CS1601
CS1601H

# Digital PFC Controller for Electronic Ballasts

## Features

- Low PFC System Cost
- Best-in-class THD
- Digital EMI Noise Shaping Reduces Conducted EMI
- Adaptive Switching Frequency Control Minimizes Boost Inductor Size
- High Efficiency Due to Zero-current Switching
- Integrated Feedback Compensation Simplifies System Design
- Comprehensive Safety Features
  - Undervoltage Lockout (UVLO)
  - Output Overvoltage Protection
  - Cycle-by-cycle Current Limiting
  - Input Voltage Brownout Protection
  - Open/Short Loop Protection for IAC & IFB Pins
  - Thermal Shutdown
- Pin placement similar to traditional boundary mode (CRM) Controllers

## Applications

- LED Power Supply/Driver
- Fluorescent Ballasts
- HID Ballasts

## Overview

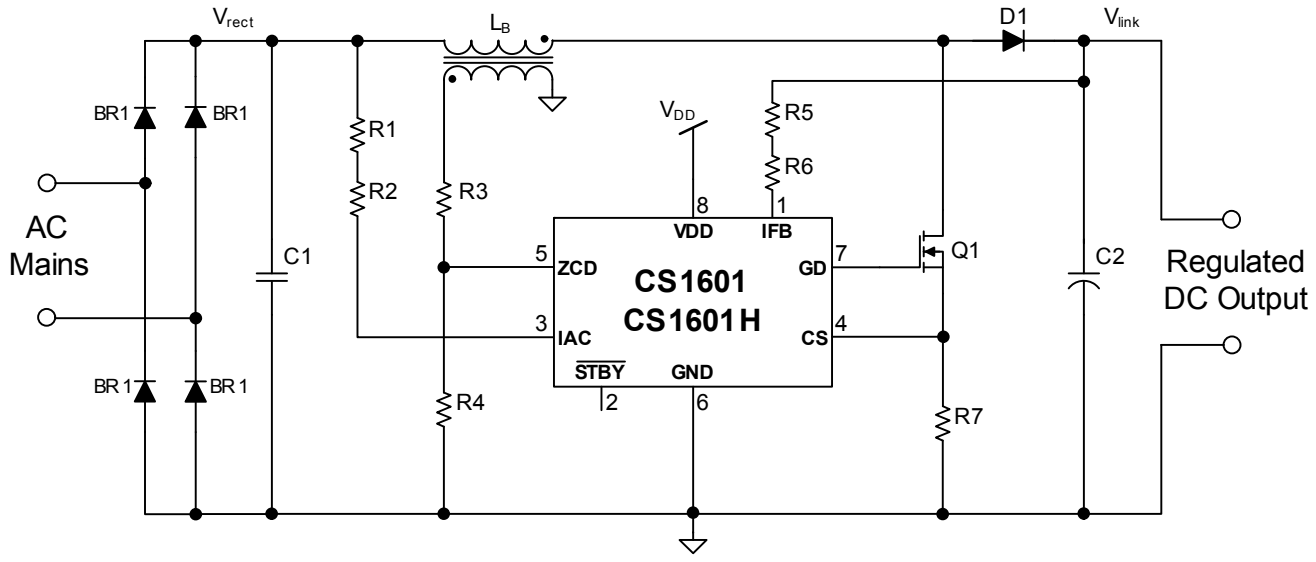
The CS1601 and CS1601H are digital power factor correction (PFC) controllers designed to deliver the lowest PFC system cost in electronic ballast applications. The controller operates in a variable frequency discontinuous conduction mode (VF-DCM) with zero-current switching (ZCS) optimized to deliver best-in-class THD and minimize the size and cost of magnetic components. The CS1601 operates at switching frequencies up to 70kHz while the CS1601H operates at frequencies extending to 100kHz.

The VF-DCM control algorithm varies both duty cycle and frequency. This spreads the EMI frequency spectrum, thus reducing conducted EMI filtering requirements. In addition, the maximum switching frequency is reached at the peak of the AC input, which allows for use of a smaller, more cost-effective boost inductor.

The feedback loop is closed through an integrated compensation network within the controller, eliminating the need for additional external components. Protection features such as overvoltage, overcurrent, open and short-circuit protection, overtemperature, and brownout protect the system during abnormal transient conditions.

### Ordering Information

See page 15.




*Preliminary Product Information* | This document contains information for a new product. Cirrus Logic reserves the right to modify this product without notice.

# 1. INTRODUCTION

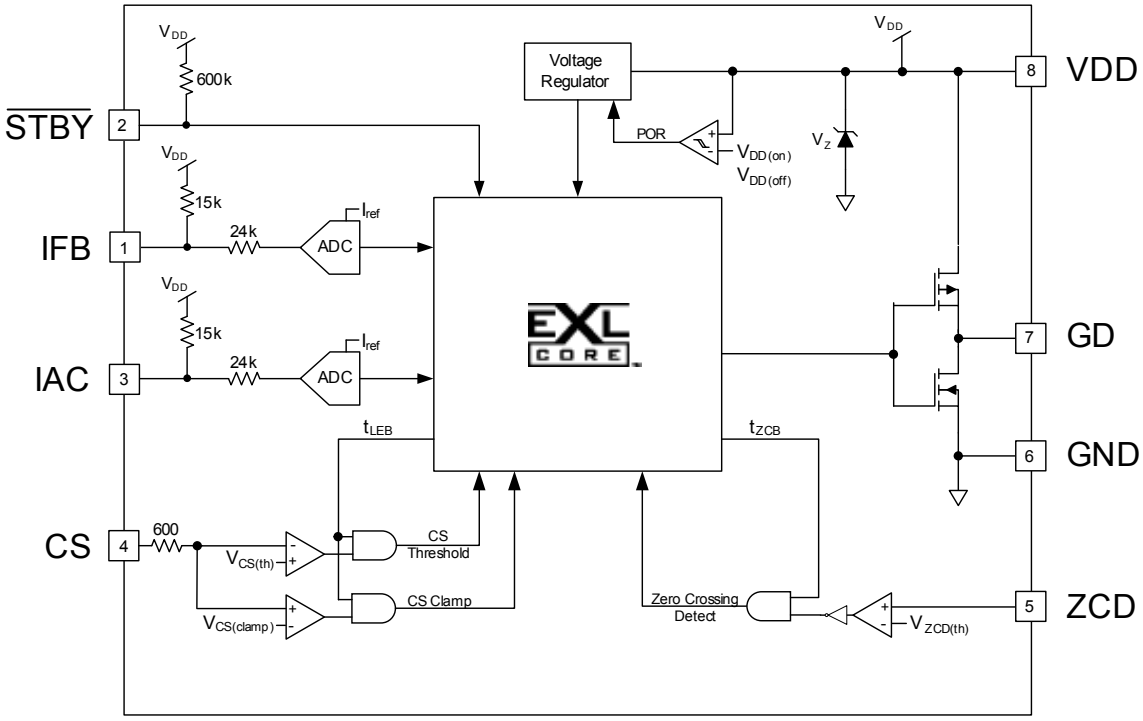



**Figure 1. CS1601 Block Diagram**

The CS1601 digital power factor correction (PFC) control IC is designed to deliver the lowest system cost by reducing the total number of system components and optimizing the EMI noise signature, which reduces the conducted EMI filter requirements. The CS1601 digital algorithm determines the behavior of the boost converter during startup, normal operation, and under fault conditions (overvoltage, overcurrent, and overtemperature).

Figure 1 illustrates a high-level block diagram of the CS1601. The PFC processor logic regulates the power transfer by using an adaptive digital algorithm to optimize the PFC active-switch (MOSFET) drive signal duty cycle and switching frequency. The adaptive controller uses independent analog-to-digital converter (ADC) channels when sensing the feedback and feedforward analog signals required to implement the digital PFC control algorithm.

The AC mains rectified voltage (on pin IAC) and PFC output link voltage (on pin IFB) are transformed by the PFC processor logic and used to generate the optimum PFC active-switch drive signal (GD) by calculating the optimal switching frequency and $t_{ON}$ time on a cycle-by-cycle basis.

An auxiliary winding is typically added to the PFC boost inductor to provide zero-current detection (ZCD) information. The ZCD acts as a demagnetization sensor used to monitor the PFC active-switching behavior and efficiency. The auxiliary voltage is normalized using an external attenuator and is connected to the ZCD pin, providing the CS1601 a mechanism to detect the valley/zero crossings. The ZCD comparator looks for the zero crossing on the auxiliary winding and switches when the auxiliary voltage is below zero. Switching in the valley of the oscillation minimizes the switching losses and reduces EMI noise.

The PFC controller uses a current sensor for overcurrent protection. The boost inductor peak current is measured across an external resistor in the switching circuit on a cycle-by-cycle basis. An overcurrent fault is generated when the sense voltage applied to the CS pin exceeds a predefined reference voltage.

The CS1601 includes a supervisor & protection circuit to manage startup, shutdown, and fault conditions. The protection circuit is designed to prevent output overvoltage as a result of load and AC mains transients. The PFC power converter main rectified voltage ($V_{rect}$) and output link voltage ($V_{link}$) are monitored for overvoltage faults which would lead to shutdown of the PFC controller. The PFC overvoltage protection is designed for auto-recovery, i.e. operation resumes once the fault clears.

## 2. PIN DESCRIPTION

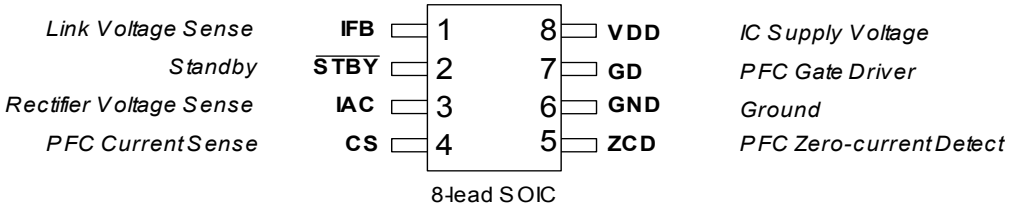



**Figure 2. CS1601 Pin Assignments**

| Pin Name | Pin # | I/O | Description |
|---|---|---|---|
| **IFB** | 1 | IN | **Link Voltage Sense** — A current proportional to the output link voltage of the PFC is input into this pin. The current is measured with an ADC. |
| **$\overline{\text{STBY}}$** | 2 | IN | **Standby** — A voltage below 0.8V puts the IC into a non-operating, low-power state. The input has an internal 600kΩ pull-up resistor to the $V_{DD}$ pin. |
| **IAC** | 3 | IN | **Rectifier Voltage Sense** — A current proportional to the rectified line voltage is input into this pin. The current is measured with an ADC. |
| **CS** | 4 | IN | **PFC Current Sense** — The current flowing in the PFC MOSFET is sensed through a resistor. The resulting voltage is applied to this pin and digitized for use by the PFC computational logic to limit the maximum current through the power FET. |
| **ZCD** | 5 | IN | **Zero-current Detect**— Boost Inductor demagnetization sensing input for zero-current detection (ZCD) information. The pin is externally connected to the PFC boost inductor auxiliary winding through an external resistor divider. |
| **GND** | 6 | PWR | **Ground** — Common reference. Current return for both the input signal portion of the IC and the gate driver. |
| **GD** | 7 | OUT | **PFC Gate Driver** — The totem pole stage is able to drive the power MOSFET with a peak current of 0.5A source and 1.0A sink. |
| **$V_{DD}$** | 8 | PWR | **IC Supply Voltage** — Supply voltage of both the input signal portion of the IC and the gate driver. A storage capacitor is connected on this pin to serve as a reservoir for operating current for the device, including the gate drive current to the power transistor. This pin is clamped to a maximum voltage ($V_Z$) by an internal zener function. |

# 3. CHARACTERISTICS AND SPECIFICATIONS

## 3.1 Electrical Characteristics

*Typical* characteristics conditions:

$T_A$ = 25°C, $V_{DD}$ = 13V, GND = 0V

All voltages are measured with respect to GND.

Unless otherwise specified, all current are positive when flowing into the IC.

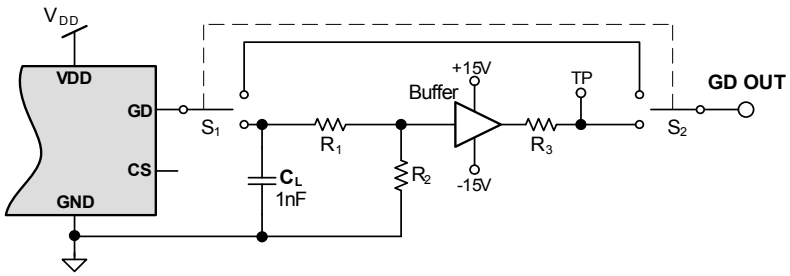
*Minimum/Maximum* characteristics conditions:

$T_J$ = -40° to +125°C, $V_{DD}$ = 10V to 15V, GND = 0V

| Parameter | Condition | Symbol | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| ***$V_{DD}$ Supply Voltage*** | | | | | | |
| Operating Range | After Turn-on | $V_{DD}$ | 7.9 | - | 17.0 | V |
| Turn-on Threshold Voltage | $V_{DD}$ Increasing | $V_{DD(on)}$ | 9.8 | 10.2 | 10.5 | V |
| Turn-off Threshold Voltage (UVLO) | $V_{DD}$ Decreasing | $V_{DD(off)}$ | 7.9 | 8.1 | 8.3 | V |
| UVLO Hysteresis | | $V_{Hys}$ | - | 2.1 | - | V |
| Zener Voltage | $I_{DD}$ = 20mA | $V_Z$ | 17.0 | 17.9 | 18.7 | V |
| ***$V_{DD}$ Supply Current*** | | | | | | |
| Startup Supply Current | $V_{DD} = V_{DD(on)}$ | $I_{ST}$ | - | 68 | 80 | µA |
| Operating Supply Current [3]<br>CS1601<br>CS1601H | <br>$C_L$ = 1nF, fsw = 70kHz<br>$C_L$ = 1nF, fsw = 100kHz | $I_{DD}$ | <br>-<br>- | <br>1.5<br>1.75 | <br>1.7<br>1.95 | <br>mA<br>mA |
| Standby Supply Current | $\overline{STBY}$ < 0.8V | $I_{SB}$ | - | 80 | 112 | µA |
| ***Reference*** | | | | | | |
| Reference Current | | $I_{ref}$ | - | 129 | - | µA |
| ***PFC Gate Drive*** | | | | | | |
| Output Source Resistance | $I_{GD}$ = 100mA, $V_{DD}$ = 13V | $R_{OH}$ | - | 9 | - | Ω |
| Output Sink Resistance | $I_{GD}$ = -200mA, $V_{DD}$ = 13V | $R_{OL}$ | - | 6 | - | Ω |
| Rise Time [3] | $C_L$ = 1nF, $V_{DD}$ = 13V | $t_r$ | - | 32 | 45 | ns |
| Fall Time [3] | $C_L$ = 1nF, $V_{DD}$ = 13V | $t_f$ | - | 15 | 25 | ns |
| Output Voltage Low State | $I_{GD}$ = -200mA, $V_{DD}$ = 13V | Vol | - | 0.9 | 1.3 | V |
| Output Voltage High State | $I_{GD}$ = 100mA, $V_{DD}$ = 13V | Voh | 11.3 | 11.8 | - | V |
| ***Zero-current Detection (ZCD)*** | | | | | | |
| ZCD Threshold | | $V_{ZCD(th)}$ | - | 50 | - | mV |
| ZCD Blanking | | $t_{ZCB}$ | - | 200 | - | ns |
| ZCD Sink/Source Current | $V_{ZCD}$ = 50mV | $I_{ZCD}$ | -2 | -1 | 2 | mA |
| Upper Voltage Clamp | $I_{ZCD}$ = 1mA | $V_{CLP}$ | - | $V_{DD}$ | - | V |
| ***Overvoltage Protection (OVP)*** | | | | | | |
| IFB Current at Startup Mode | | $I_{IFB(startup)}$ | - | 116 | - | µA |
| IFB Current at Normal Mode | | $I_{IFB(norm)}$ | - | 129 | - | µA |
| OVP Threshold | $I_{ref}$ = 129µA | $I_{OVP}$ | - | 139 | - | µA |
| OVP Hysteresis | $I_{ref}$ = 129µA | $I_{OVP(Hy)}$ | - | 2 | - | µA |

| Parameter | Condition | Symbol | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| ***Overcurrent Protection (OCP)*** | | | | | | |
| Current Sense Reference Clamp | | $V_{CS(clamp)}$ | - | 1.0 | - | V |
| Threshold on Current Sense | | $V_{CS(th)}$ | - | 0.5 | - | V |
| Leading Edge Blanking | | $t_{LEB}$ | - | 300 | - | ns |
| Delay to Output | | $t_{CS}$ | - | 60 | 350 | ns |
| ***Brownout Protection (BP)*** | | | | | | |
| Input Brownout Protection Threshold | gate drive turns off | $I_{BP(lower)}$ | - | 31.6 | - | µA |
| Input Brownout Recovery Threshold | gate drive turns on | $I_{BP(upper)}$ | - | 39.6 | - | µA |
| ***Thermal Protection*** [1] | | | | | | |
| Thermal Shutdown Threshold | | $T_{SD}$ | 134 | 147 | 159 | °C |
| Thermal Shutdown Hysteresis | | $T_{SD(Hy)}$ | - | 9 | - | °C |
| ***$\overline{STBY}$ Input*** [2] | | | | | | |
| Logic Threshold Low | | | - | - | 0.8 | V |
| Logic Threshold High | | | $V_{DD}$-0.8 | - | - | V |

Notes:
1. Specifications guaranteed by design and are characterized and correlated using statistical process methods.
2. $\overline{STBY}$ is designed to be driven by an open collector. The input is internally pulled up with a 600 kΩ resistor.
3. For test purposes, load capacitance ($C_L$) is 1 nF and is connected as shown in the following diagram.



## 3.2 Absolute Maximum Ratings

| Pin | Symbol | Parameter | | Value | Unit |
|---|---|---|---|---|---|
| 8 | $V_{DD}$ | IC Supply Voltage | | $V_Z$ | V |
| 1,3,4,5 | - | Analog Input Maximum Voltage | | -0.5 to $V_Z$ | V |
| 1,3,4,5 | - | Analog Input Maximum Current | | 50 | mA |
| 7 | $V_{GD}$ | Gate Drive Output Voltage | | -0.3 to $V_Z$ | V |
| 7 | $I_{GD}$ | Gate Drive Output Current | | -1.0 / +0.5 | A |
| - | $P_D$ | Total Power Dissipation @ $T_A$ = 50 °C | | 600 | mW |
| - | $\theta_{JA}$ | Junction-to-Ambient Thermal Impedance | | 107 | °C/W |
| - | $T_A$ | Operating Ambient Temperature Range[1] | | -40 to +125 | °C |
| - | $T_J$ | Junction Temperature Operating Range | | -40 to +125 | °C |
| - | $T_{Stg}$ | Storage Temperature Range | | -65 to +150 | °C |
| All Pins | ESD | Electrostatic Discharge Capability | Human Body Model<br>Machine Model<br>Charged Device Model | 2000<br>200<br>500 | V |

Notes:
4. The CS1601 has an internal shunt regulator that limits the voltage on the $V_{DD}$ pin. $V_Z$, the shunt regulation voltage, is defined in the *VDD Supply Voltage* section of the *Characteristics and Specifications* section on the previous page.
5. Long term operation at the maximum junction temperature will result in reduced product life. Derate internal power dissipation at the rate of 50 mW/ °C for variation over temperature.

**WARNING:**

Operation at or beyond these limits may result in permanent damage to the device.
Normal operation is not guaranteed at these extremes.

# 4. TYPICAL ELECTRICAL PERFORMANCE

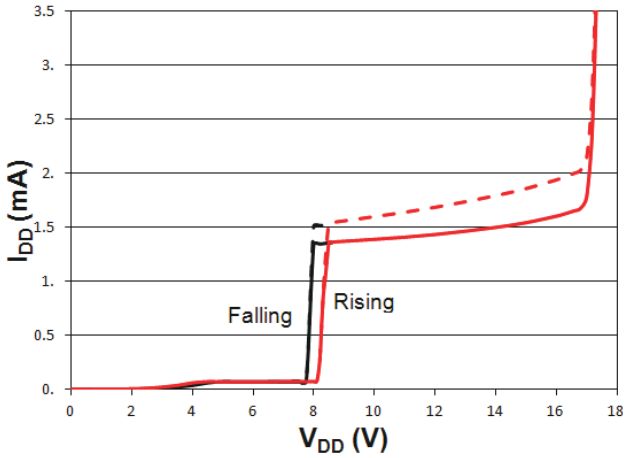



**Figure 3. Supply Current vs. Supply Voltage**

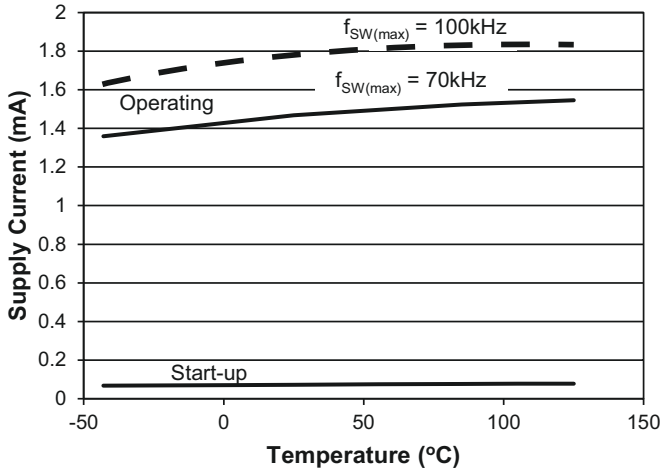



**Figure 4. Supply Current ($I_{SB}$, $I_{ST}$, $I_{DD}$) vs. Temp**

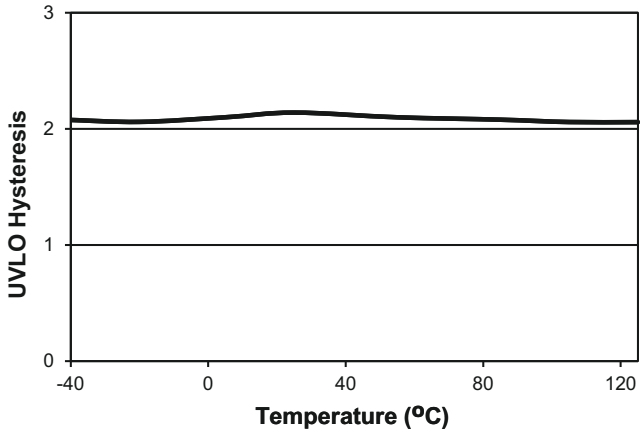



**Figure 5. UVLO Hysteresis vs. Temp**

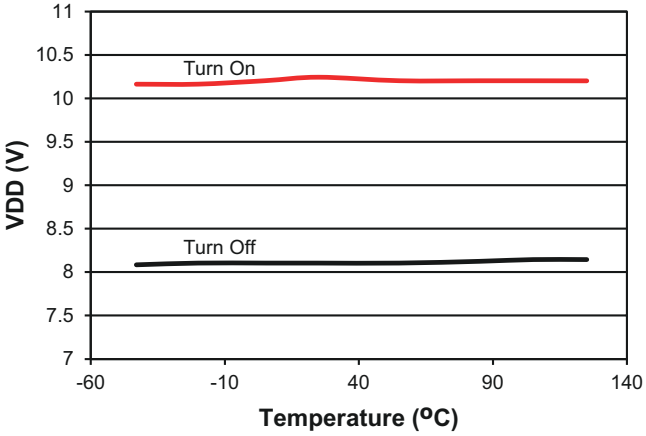



**Figure 6. Turn-on & Turn-off Threshold vs. Temp**

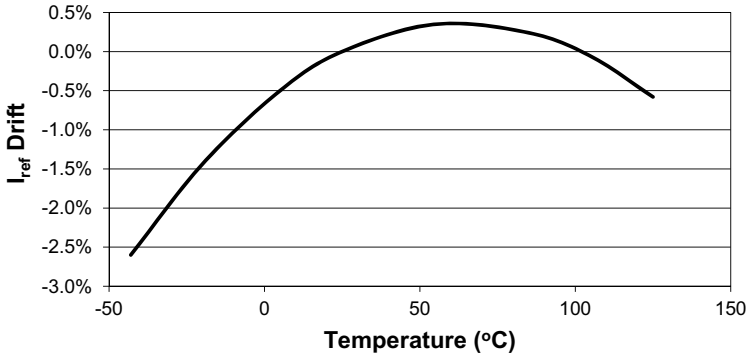



**Figure 7. Reference Current ($I_{ref}$) Drift vs. Temp**

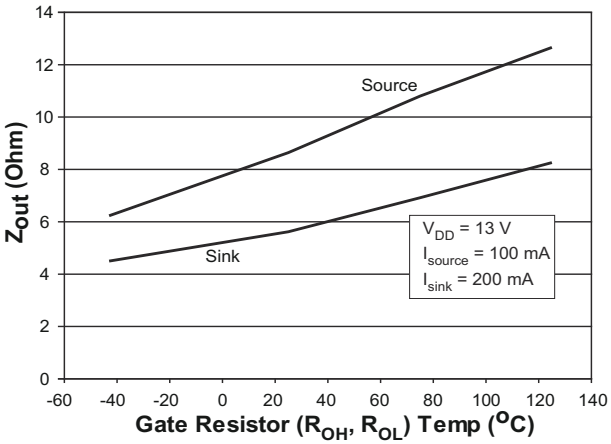



**Figure 8. Gate Resistance ($R_{OH}$, $R_{OL}$) vs. Temp**

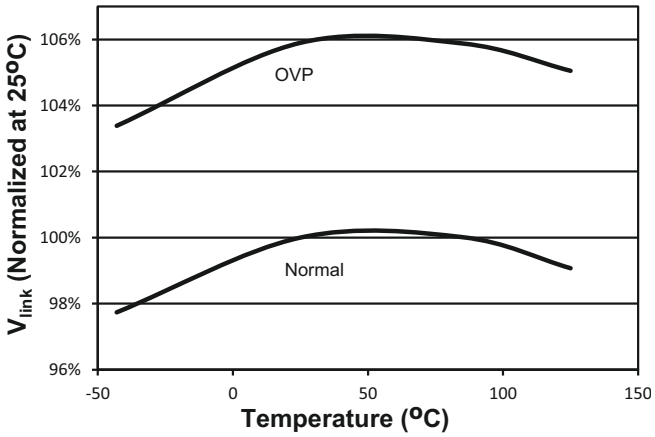



**Figure 9. OVP vs. Temp**

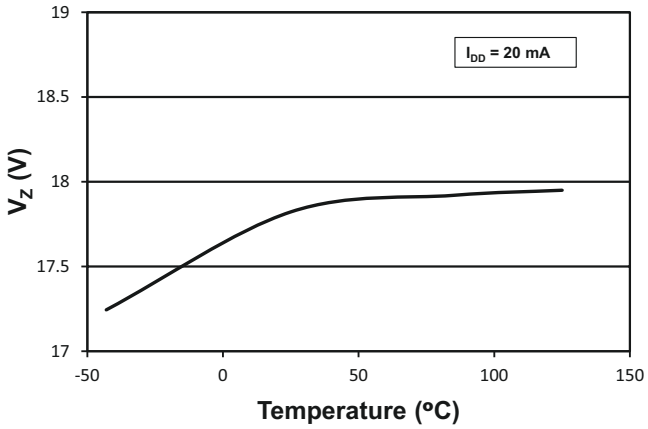



**Figure 10. $V_{DD}$ Zener Voltage vs. Temp**

# 5. GENERAL DESCRIPTION

The CS1601 offers numerous features, options, and functional capabilities to the electronic product lighting designer. This digital PFC control IC is designed to replace legacy analog PFC controllers with minimal design effort.

## 5.1 PFC Operation

One key feature of the CS1601 is its operating frequency profile. Figure 11 illustrates how the frequency varies over half cycle of the line voltage in steady-state operation. When power is first applied to the CS1601, it examines the line voltage and adapts its operating frequency to the line voltage as shown in Figure 11. The operating frequency is varied from the peak to the trough of the AC input. During startup, the control algorithm generates maximum power while operating in critical conduction mode (CRM), providing an approximate square-wave current envelop within every half-line cycle.

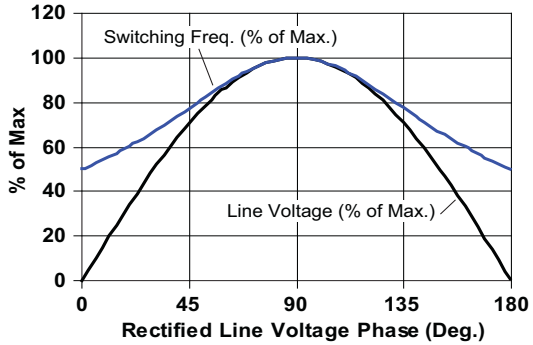



**Figure 11. Switching Frequency vs. Phase Angle**

Figure 12 illustrates how the operating frequency of CS1601 (as a percentage of maximum frequency) changes with output power and the peak of the line voltage.

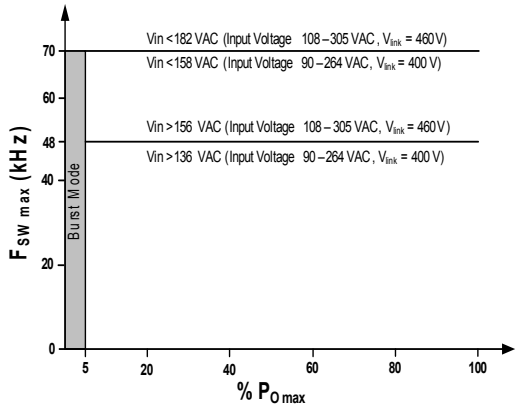



**Figure 12. CS1601 Max Switching Freq vs. Output Power**

Figure 13 illustrates how the operating frequency of CS1601H changes with output power and the peak of the line voltage.

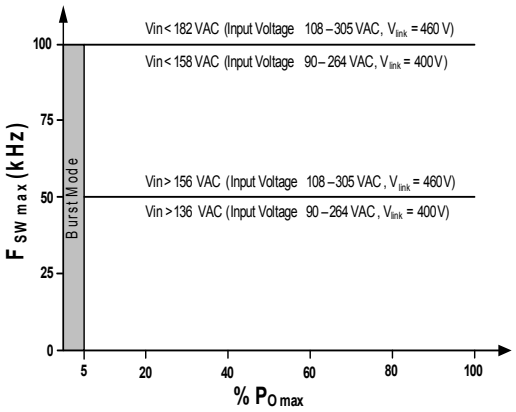



**Figure 13. CS1601H Max Switching Freq vs. Output Power**

When $P_O$ falls below 5%, the CS1601 changes to Burst Mode. (Refer to Burst Mode section for more information.)

The CS1601 is designed to function as a DCM controller. However, during peak periods, the controller may interchange control methods and operate in a quasi-critical-conduction mode (quasi-CRM) at low line. For example, at 108 VAC main input under full load, the PFC controller will function as a quasi-CRM controller at the peak of the AC line cycle, as shown in Figure 14.

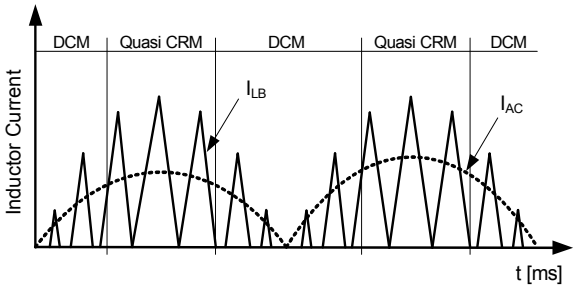



**Figure 14. DCM and quasi-CRM Operation with CS1601**

The zero-current detection (ZCD) of the boost inductor is achieved using an auxiliary winding. When the stored energy of the inductor is fully released to the output, the voltage on the ZCD pin decreases, triggering a new switching cycle. This quasi-resonant switching allows the active switch to be turned on with near-zero inductor current, resulting in a nearly lossless switch event. This minimizes turn-on losses and EMI noise created by the switching cycle. Power factor correction control is achieved during light load by using on-time modulation.

## 5.2 Startup vs. Normal Operation Mode

The CS1601 has two discrete operation modes: startup and normal. Startup mode will be activated when $V_{link}$ is less than 90% of nominal value, $V_{O(startup)}$ and remains active until $V_{link}$ reaches 100% of nominal value, as shown in Figure 15. Startup mode is activated during initial system power-up. Any $V_{link}$ drop to less than $V_{O(startup)}$, such as a load change, can cause the system to enter startup mode until $V_{link}$ is brought back into regulation.

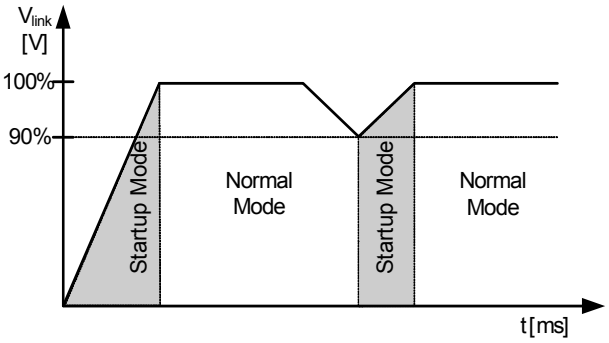



**Figure 15. Startup and Normal Modes**

Startup mode is defined as a surge of current delivering maximum power to the output regardless of the load. During every active switch cycle, the 'ON' time is calculated to drive a constant peak current over the entire line cycle. However, the 'OFF' time is calculated based on the DCM/CCM boundary equation.

## 5.3 Burst Mode

Burst mode is utilized to improve system efficiency when the system output power ($P_o$) is <5% of nominal. Burst mode is implemented by intermittently disabling the PFC over a full half-line period under light-load conditions, as shown in Figure 16.

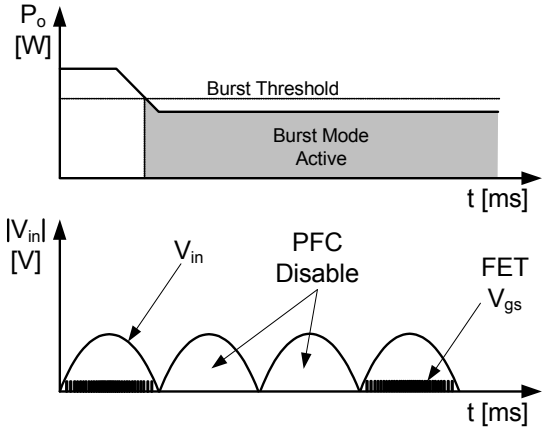



**Figure 16. Burst Modes**

## 5.4 Output Power and PFC Boost Inductor

In normal operating mode, the nominal output power is estimated by the following equation.

$$P_o = \alpha \times \eta \times (V_{in(min)})^2 \times \frac{V_{link} - (V_{in(min)} \times \sqrt{2})}{2 \times f_{max} \times L_B \times V_{link}} \quad \text{[Eq.1]}$$

where:

$P_o$ rated output power of the system

$\eta$ efficiency of the boost converter (estimated as 100% by the PFC algorithm)

$V_{in(min)}$ minimum RMS line voltage measured after the rectifier and EMI filter. $V_{in(min)}$ is equal to 90Vrms or 108Vrms depending on the AC Line Voltage operating range.

$V_{link}$ nominal PFC output voltage; $V_{link}$ = 400V when $V_{in(min)}$ = 90Vrms or $V_{link}$ = 460V when $V_{in(min)}$ = 108Vrms

$f_{max}$ maximum switching frequency; for the CS1601 $f_{max}$ = 70kHz and the CS1601H $f_{max}$ = 100kHz

$L_B$ boost inductor specified by rated power requirement

$\alpha$<1 margin factor to guarantee rated output power ($P_o$) against boost inductor tolerances.

Equation 1 is provided for explanation purposes only. Using substituted required design values for $V_{link}$ and $f_{max}$ gives the following equation:

$$P_o = \alpha \times \eta \times (108V)^2 \times \frac{460V - (108V \times \sqrt{2})}{2 \times 70kHz \times L_B \times 460V} \quad \text{[Eq.2]}$$

Changing the value for the $V_{link}$ voltage is not recommended.

Solving Equation 2 for the PFC boost inductor $L_B$ gives the following equation:

$$L_B = \alpha \times \eta \times (108V)^2 \times \frac{460V - (108V \times \sqrt{2})}{2 \times 70kHz \times P_o \times 460V} \quad \text{[Eq.3]}$$

If a value of the boost inductor other than that obtained from Equation 3 above is used, the total output power capability as well as the minimum input voltage threshold will differ according to Equation 2. Note that if the input voltage drops below 108Vrms and the inductance value is <$L_B$, the link voltage $V_{link}$ will drop below 460V and fall out of regulation.

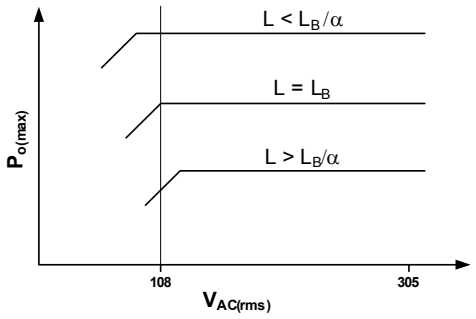



**Figure 17. Relative Effects of Varying Boost Inductance**

## 5.5 PFC Output Capacitor

The value of the PFC output capacitor should be chosen based upon voltage ripple and hold-up requirements. To ensure system stability with the digital controller, the recommended value of the capacitor is within the range of 0.25µF/watt to 0.5µF/watt with a $V_{link}$ voltage of 460V.

## 5.6 Output IFB Sense & Input IAC Sense

A current proportional to the PFC output voltage, $V_{link}$, is supplied to the IC on pin IFB and is used as a feedback control signal. This current is compared against an internal fixed-value reference current.

The ADC is used to measure the magnitude of the $I_{IFB}$ current through resistor $R_{IFB}$. The magnitude of the $I_{IFB}$ current is then compared to an internal reference current of ($I_{ref}$) 129µA.

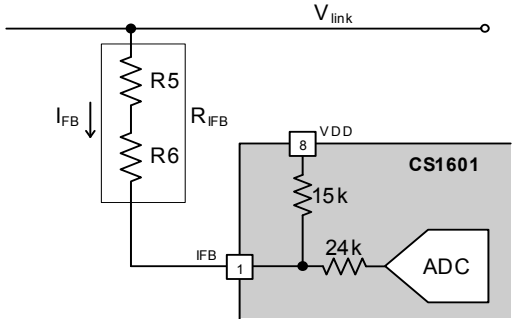



**Figure 18. IFB Input Pin Model**

Resistor $R_{IFB}$ sets the feedback current and is calculated as follows:

$$R_{IFB} = \frac{V_{link} - V_{DD}}{I_{ref}} = \frac{460V - V_{DD}}{129mA} \quad \text{[Eq.4]}$$

By using digital loop compensation, the voltage feedback signal does not require an external compensation network.

A current proportional to the AC input voltage is supplied to the IC on pin IAC and is used by the PFC control algorithm.

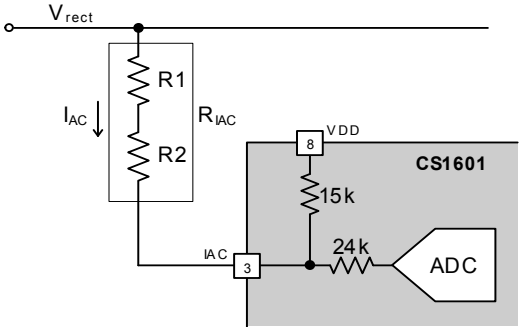



**Figure 19. IAC Input Pin Model**

Resistor $R_{IAC}$ sets the IAC current and is derived as follows:

$$R_{IAC} = R_{IFB} \quad \text{[Eq.5]}$$

For optimal performance, resistors $R_{IAC}$ & $R_{IFB}$ should use 1% tolerance or better resistors for best $V_{link}$ voltage accuracy.

## 5.7 Valley Switching

The zero-current detection (ZCD) pin is monitored for demagnetization in the auxiliary winding of the boost inductor ($L_B$). The ZCD circuit is designed to detect the $V_{Aux}$ valley/zero crossings by sensing the voltage transformed onto the auxiliary winding of $L_B$.

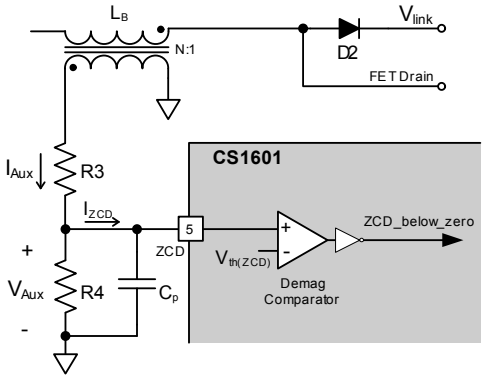



**Figure 20. ZCD Input Pin Model**

The objective of zero-voltage switching is to initiate each MOSFET switching cycle when its drain-source voltage is at the lowest possible voltage potential, thus reducing switching losses. CS1601 uses an auxiliary winding on the PFC boost inductor to implement zero-voltage switching.

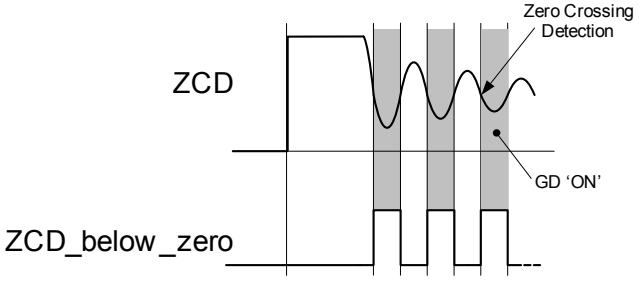



**Figure 21. Zero-voltage Switch**

During each switching cycle, when the boost diode current reaches zero, the boost MOSFET drain-source voltage begins oscillating at the resonant frequency of the boost inductor and MOSFET parasitic output capacitance. The ZCD_below_zero signal transitions from high to low just prior to a local minimum of the MOSFET drain-source voltage oscillation. The zero-crossing detect circuit ensures that a ZCD_below_zero pulse will only be generated when the comparator output is continuously high for a nominal time period ($t_{ZCB}$) of 200ns. Therefore, any negative edges on the comparator's output due to spurious glitches will not cause a pulse to be generated.

Due to the CS1601's variable-frequency control, the MOSFET switching cycle will not always be initiated at the first resonant

table below depicts approximate values for R3 and R4 for a range of boost-to-auxiliary inductor turns ratio, N.

| N | ~R3 | ~R4 |
|---|---|---|
| 9 | 46kΩ | 1.75kΩ |
| 10 | 42kΩ | 1.75kΩ |
| 11 | 37.5kΩ | 1.75kΩ |
| 12 | 35.5kΩ | 1.75kΩ |
| 13 | 32kΩ | 1.75kΩ |
| 14 | 29.5kΩ | 1.75kΩ |
| 15 | 27.5kΩ | 1.75kΩ |

**Table 1. Aux Inductor Turns Ratio vs. R3 and R4**

Resistors R3 and R4 were calculated using $V_{link}$ = 460V and $C_p$ = 10pF.

Equation 6 is used to calculate the cut-off frequency defined by the RC circuit at the ZCD pin.

$$f_c = 1/(2\pi(R3 \parallel R4)C_p) \quad \text{[Eq.6]}$$

where:

$f_c$ The cut-off frequency, $f_c$, needs to be 10x the ringing frequency.

$C_p$ Capacitance at the ZCD pin

## 5.8 Brownout Protection

The CS1601 brownout detection circuit monitors the peak of the $V_{rect}$ input voltage and disables the PWM switching when it drops below a pre-determined threshold. Hysteresis and minimum detection time are provided to avoid brownout detection during short input transients. When brownout is detected, the CS1601 enters standby mode. On recovery from brownout, it re-enters normal operating mode.

Current $I_{AC}$ is proportional to the AC input voltage $V_{rect}$, where $V_{rect} = R_{IAC} \times I_{AC}$ and $R_{IAC}$ = R1+R2 in Figure 19 on page 11. The digitized current applied to the IAC pin is monitored by the brownout protection algorithm. When $V_{rect}$ drops below the brownout detection threshold, the CS1601 triggers a timer. The IC asserts the brownout protection and stops the gate-drive switching only if the timer exceeds 56ms. This is the equivalent of 7 rectified line cycles at 60Hz.

During the brownout state, the device continues monitoring the input line voltage. The device exits the brownout state when $I_{AC}$ exceeds the brownout upper threshold for at least 56ms. Typical values for the lower ($I_{BP(lower)}$) and upper ($I_{BP(upper)}$) brownout thresholds are 31.6µA and 39.6µA, respectively.

The overpower protection may activate prior to brownout protection, depending on the load.

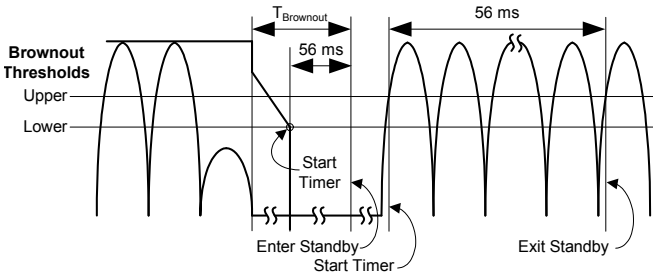



**Figure 22. Brownout Sequence**

The maximum response time of the brownout protection feature occurs at light-load conditions. It is calculated by Equation 7.

$$T_{Brownout} = 8\,ms + \frac{8\,ms}{5\,V}(128\,V - V_{BP(th)}) + 56\,ms \quad \text{[Eq.7]}$$

$$= 8 + \frac{8}{5}(128 - 94.8) + 56 = 117ms$$

where:

$V_{BP(th)}$ Brownout threshold voltage, $V_{BP(th)} = I_{BP(lower)} \times R_{IAC}$

## 5.9 Overvoltage Protection

The overvoltage protection (OVP) will trigger immediately and stop the gate drive when the current into the IFB pin ($I_{OVP}$) exceeds 105% of the reference current ($I_{ref}$) value. The IC resumes gate drive switching when the measured current at IFB drops below $I_{OVP} - I_{OVP(Hy)}$. Equation 8 is used to calculate the OVP threshold ($V_{OVP}$).

$$V_{OVP} = R_{IFB} \times I_{OVP} + V_{DD} \quad \text{[Eq.8]}$$

## 5.10 Overcurrent Protection

To limit boost inductor current through the FET and to prevent boost inductor saturation conditions, the CS1601 incorporates a cycle-by-cycle peak inductor current limit circuit using an external shunt resistor to 'sense' the FET source current accurately. The overcurrent protection (OCP) circuit is designed to monitor the current when the active switch is turned on. The OCP circuit is enabled after the leading-edge blanking time ($t_{LEB}$). The shunt voltage is compared to a reference voltage, $V_{cs(th)}$, to determine whether an overcurrent condition exists. The OCP circuit triggers immediately, allowing the OCP algorithm to turn off the gate driver.

The overcurrent protection circuit is also designed to monitor for a catastrophic overcurrent occurrence by sensing sudden and abnormal operating currents. A second OCP threshold, $V_{cs(clamp)}$, determines whether a severe overcurrent condition exists. This immediately turns off the gate drive and the system enters a restart mode. The CS1601 inhibits all switching operations for approximately 1.6ms then attempts to restart normal operation.

## 5.11 Overpower Protection

The CS1601 incorporates an internal Overpower Protection (OPP) algorithm. This provides protection from overload conditions. This algorithm uses the condition that output power is a function of the boost inductor (Section 5.4).

Under moderate overload, $V_{link}$ may droop up to 10% while maintaining rated power and PFC. Further increasing the load current causes $V_{link}$ to drop below the startup threshold (~360V). Below this threshold, the circuit changes its operating mode to startup with more power available to raise $V_{link}$. As $V_{link}$ reaches its nominal value, startup mode is canceled and power is now limited to the rated value. If the overload is still present, this cycle will repeat.

If a sustained overload, or a repeated cycle of overload events is detected for greater than 112 mS, the CS1601 shuts down for 2.5 seconds, then attempts to restart.

## 5.12 Open/Short Loop Protection

If the PFC output sense resistor, $R_{IFB}$, fails (open or short to GND), the measured output voltage decreases at a slew rate of about 2 V/µs, which is determined by the ADC sampling rate. The IC stops the gate drive when the measured output voltage is lower than the measured line voltage. The IC resumes gate drive switching when the current into the IFB pin becomes larger than or equal to the current into the IAC pin and $V_{link}$ is greater than the peak of the line voltage ($V_{rect(pk)}$). The maximum response time of open/short loop protection for $R_{IFB}$ is about 150 µs.

If the PFC input sense resistor $R_{IAC}$ fails (open or short to GND), the current reference signal supplied to the IC on pin IAC falls to zero.

## 5.13 Internal Overtemperature Protection

An internal thermal sensor triggers a shutdown when the temperature exceeds 135°C (nominal) on the silicon. The sensor sends a signal to the core that supplies current to all internal digital logic, cutting off power from them. Once the temperature of the IC has dropped by 9°C (nominal), the sensor resets, allowing power to the logic.

## 5.14 Standby ($\overline{\text{STBY}}$) Function

The standby ($\overline{\text{STBY}}$) pin provides a means by which an external signal can cause the CS1601 to enter a non-operating, low-power state. The $\overline{\text{STBY}}$ input is intended to be driven by an open-collector/open-drain device. Internal to the pin, there is a pull-up resistor connected to the $V_{DD}$ pin as shown in Figure 23. Since the pull-up resistor has a high impedance, the user may need to provide a filter capacitor (up to 1000 pF) on this pin.

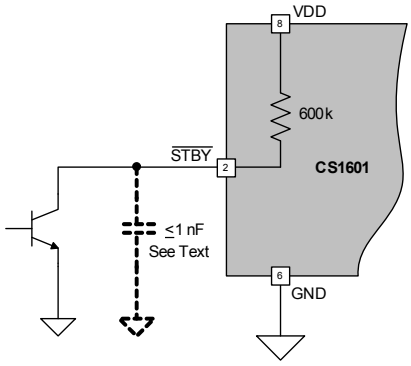



**Figure 23. $\overline{\text{STBY}}$ Pin Connection**

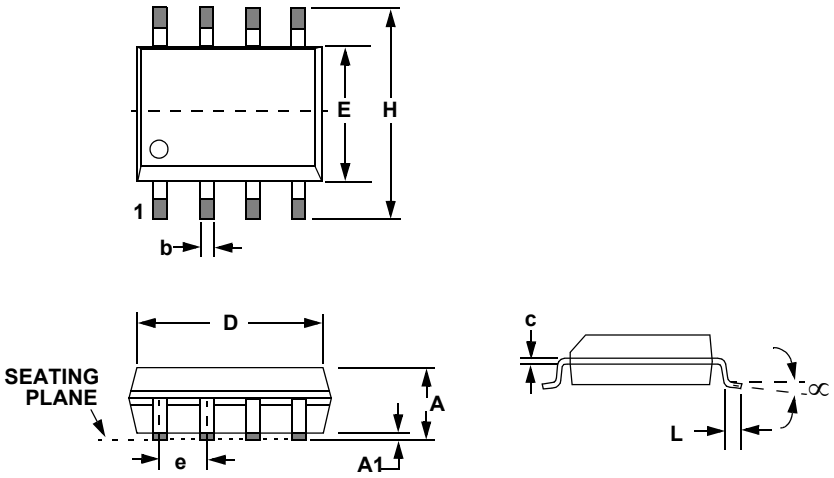
When the $\overline{\text{STBY}}$ pin is not used, it is recommended that the pin be tied to $V_{DD}$ (pulled high).

## 5.15 Summary of Equations

| Eq. # | Equation | Variables/Recommended Values |
|---|---|---|
| 1 | **Output Power** (page 10)<br>$P_o = \alpha \times \eta \times (V_{in(min)})^2 \times \frac{V_{link} - (V_{in(min)} \times \sqrt{2})}{2 \times f_{max} \times L_B \times V_{link}}$ | $P_o$ Rated output power of the system.<br>$\eta$ Efficiency of the boost converter (estimated as 100% by the PFC algorithm).<br>$V_{in(min)}$ Minimum RMS line voltage is 90Vrms, measured after the rectifier and EMI filter.<br>$V_{link}$ Nominal PFC output voltage must be 400V.<br>$f_{max}$ Maximum switching frequency is 70kHz.<br>$L_B$ Boost inductor specified by rated power requirement.<br>$\alpha$ Margin factor to guarantee rated output power ($P_o$) against boost inductor tolerances.<br>$R_{IAC}$ Value of the IAC pin sense resistor(s).<br>$R_{IFB}$ Value of the IFB pin sense resistor(s).<br>$I_{ref}$ Value of the fixed, internal reference current.<br>$f_c$ The cut-off frequency, $f_c$, needs to be 10x the ringing frequency or $f_c$ = 10MHz.<br>$C_p$ Capacitance at the ZCD pin. $C_p$<10pF.<br>$V_{BP(th)}$ Brownout threshold voltage. $V_{BP(th)}$ = 94.8V.<br>$C_{out}$ Value of the output capacitor in microfarads.<br>$f_{line(min)}$ Minimum line frequency.<br>$V_{DD}$ IC Supply Voltage.<br>$V_{OVP}$ OVP threshold.<br>$I_{OVP}$ Current into the IFB pin. |
| 2 | **Output Power w/ recommended values** (page 10)<br>$P_o = \alpha \times \eta \times (90Vrms)^2 \times \frac{400V - (90Vrms \times \sqrt{2})}{2 \times 70kHz \times L_B \times 400V}$ | |
| 3 | **Boost Inductor** (page 10)<br>$L_B = \alpha \times \eta \times (90Vrms)^2 \times \frac{400V - (90Vrms \times \sqrt{2})}{2 \times 70kHz \times P_o \times 400V}$ | |
| 4 | **Output IFB Sense Resistor** (page 11)<br>$R_{IFB} = \frac{V_{link} - V_{DD}}{I_{ref}} = \frac{400V - V_{DD}}{129\mu A}$ | |
| 5 | **Input IAC Sense Resistor** (page 11)<br>$R_{IAC} = R_{IFB}$ | |
| 6 | **Auxiliary Winding Cut-off Frequency** (page 12)<br>$f_c = 1/(2\pi(R3 \parallel R4)C_p)$ | |
| 7 | **Maximum Response Time for Brownout**: (page 12)<br>$T_{Brownout} = 8ms + \frac{8ms}{5V}(128V - V_{BP(th)}) + 56ms$ | |
| 8 | **Overvoltage Protection** (page 12)<br>$V_{OVP} = R_{IFB} \times I_{OVP} + V_{DD}$ | |
| 9 | **Boost Inductor Peak Current**<br>$I_{LB(pk)} = \frac{4 \times P_O}{\eta \times V_{in(min)} \times \sqrt{2}}$ | |
| 10 | **Boost Inductor RMS Current**<br>$I_{LB(rms)} = \frac{P_O}{V_{in(min)} \times \eta}$ | |
| 11 | **$V_{link}$ Voltage Ripple**<br>$\Delta V_{link(rip)} = \frac{P_O}{2\pi \times f_{line(min)} \times V_{link} \times C_{out}}$ | |

## 6. PACKAGE DRAWING

### 8L SOIC (150 MIL BODY) PACKAGE DRAWING




| | INCHES | | MILLIMETERS | |
|---|---|---|---|---|
| DIM | MIN | MAX | MIN | MAX |
| A | 0.053 | 0.069 | 1.35 | 1.75 |
| A1 | 0.004 | 0.010 | 0.10 | 0.25 |
| B | 0.013 | 0.020 | 0.33 | 0.51 |
| C | 0.007 | 0.010 | 0.19 | 0.25 |
| D | 0.189 | 0.197 | 4.80 | 5.00 |
| E | 0.150 | 0.157 | 3.80 | 4.00 |
| e | 0.040 | 0.060 | 1.02 | 1.52 |
| H | 0.228 | 0.244 | 5.80 | 6.20 |
| L | 0.016 | 0.050 | 0.40 | 1.27 |
| ∝ | 0° | 8° | 0° | 8° |

***JEDEC # MS-012***

## 7. ORDERING INFORMATION

| Part # | Temperature Range | Package Description |
|---|---|---|
| CS1601-FSZ | -40 °C to +125 °C | 8-lead SOIC, Lead (Pb) Free |

## 8. ENVIRONMENTAL, MANUFACTURING, & HANDLING INFORMATION

| Model Number | Peak Reflow Temp | MSL Rating[a] | Max Floor Life[b] |
|---|---|---|---|
| CS1601-FSZ | 260 °C | 2 | 365 Days |

a. MSL (Moisture Sensitivity Level) as specified by IPC/JEDEC J-STD-020.

b. Stored at 30°C, 60% relative humidity.

# 9. REVISION HISTORY

| Revision | Date | Changes |
|---|---|---|
| PP1 | NOV 2010 | Preliminary Release - Updated block diagram and *General Description* section. |
| PP2 | DEC 2010 | Updated *Brownout Protection* section, *Overcurrent Protection* section. Added *Current Sense Reference Clamp* specification. |
| PP3 | JAN 2011 | Updated $\overline{STBY}$ pin and description. |
| PP4 | APR 2011 | Updated *Characteristics and Specifications* section. |
| PP5 | May 2011 | Updated *Typical Electrical Performance* section. |
| PP6 | JUN 2011 | Updated *Characteristics and Specifications* section. |

## Contacting Cirrus Logic Support

For all product questions and inquiries contact a Cirrus Logic Sales Representative.
To find one nearest you go to http://www.cirrus.com